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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Obsolete
Number of LABs/CLBs	1248
Number of Logic Elements/Cells	9984
Total RAM Bits	98304
Number of I/O	470
Number of Gates	513000
Voltage - Supply	2.3V ~ 2.7V
Mounting Type	Through Hole
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	599-BCPGA
Supplier Device Package	599-PGA (62.5x62.5)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/epf10k200egi599-3">https://www.e-xfl.com/product-detail/intel/epf10k200egi599-3</a>

Table 5. FLEX 10KE Performance

Application	Resources Used		Performance			Units
	LEs	EABs	-1 Speed Grade	-2 Speed Grade	-3 Speed Grade	
16-bit loadable counter	16	0	285	250	200	MHz
16-bit accumulator	16	0	285	250	200	MHz
16-to-1 multiplexer (1)	10	0	3.5	4.9	7.0	ns
16-bit multiplier with 3-stage pipeline (2)	592	0	156	131	93	MHz
256 × 16 RAM read cycle speed (2)	0	1	196	154	118	MHz
256 × 16 RAM write cycle speed (2)	0	1	185	143	106	MHz

**Notes:**

- (1) This application uses combinatorial inputs and outputs.  
 (2) This application uses registered inputs and outputs.

Table 6 shows FLEX 10KE performance for more complex designs. These designs are available as Altera MegaCore® functions.

Table 6. FLEX 10KE Performance for Complex Designs

Application	LEs Used	Performance			Units
		-1 Speed Grade	-2 Speed Grade	-3 Speed Grade	
8-bit, 16-tap parallel finite impulse response (FIR) filter	597	192	156	116	MSPS
8-bit, 512-point fast Fourier transform (FFT) function	1,854	23.4	28.7	38.9	μs (1)
		113	92	68	MHz
a16450 universal asynchronous receiver/transmitter (UART)	342	36	28	20.5	MHz

**Note:**

- (1) These values are for calculation time. Calculation time = number of clocks required /  $f_{\max}$ . Number of clocks required = ceiling  $[\log_2 (\text{points})/2] \times [\text{points} + 14 + \text{ceiling}]$

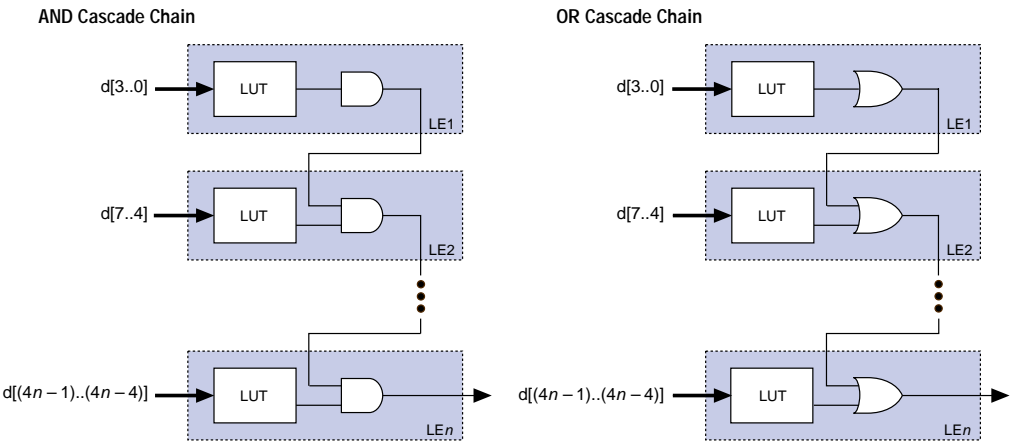
Cascade Chain

With the cascade chain, the FLEX 10KE architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. An a delay as low as 0.6 ns per LE, each additional LE provides four more inputs to the effective width of a function. Cascade chain logic can be created automatically by the Altera Compiler during design processing, or manually by the designer during design entry.

Cascade chains longer than eight bits are implemented automatically by linking several LABs together. For easier routing, a long cascade chain skips every other LAB in a row. A cascade chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from odd-numbered LAB to odd-numbered LAB (e.g., the last LE of the first LAB in a row cascades to the first LE of the third LAB). The cascade chain does not cross the center of the row (e.g., in the EPF10K50E device, the cascade chain stops at the eighteenth LAB and a new one begins at the nineteenth LAB). This break is due to the EAB's placement in the middle of the row.

Figure 10 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of  $4n$  variables implemented with  $n$  LEs. The LE delay is 0.9 ns; the cascade chain delay is 0.6 ns. With the cascade chain, 2.7 ns are needed to decode a 16-bit address.

Figure 10. FLEX 10KE Cascade Chain Operation



*LE Operating Modes*

The FLEX 10KE LE can operate in the following four modes:

- Normal mode
- Arithmetic mode
- Up/down counter mode
- Clearable counter mode

Each of these modes uses LE resources differently. In each mode, seven available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. Three inputs to the LE provide clock, clear, and preset control for the register. The Altera software, in conjunction with parameterized functions such as LPM and DesignWare functions, automatically chooses the appropriate mode for common functions such as counters, adders, and multipliers. If required, the designer can also create special-purpose functions that use a specific LE operating mode for optimal performance.

The architecture provides a synchronous clock enable to the register in all four modes. The Altera software can set `DATA1` to enable the register synchronously, providing easy implementation of fully synchronous designs.

### Clearable Counter Mode

The clearable counter mode is similar to the up/down counter mode, but supports a synchronous clear instead of the up/down control. The clear function is substituted for the cascade-in signal in the up/down counter mode. Use 2 three-input LUTs: one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer. The output of this multiplexer is ANDed with a synchronous clear signal.

### *Internal Tri-State Emulation*

Internal tri-state emulation provides internal tri-states without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable (OE) signals select which signal drives the bus. However, if multiple OE signals are active, contending signals can be driven onto the bus. Conversely, if no OE signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The Altera software automatically implements tri-state bus functionality with a multiplexer.

### *Clear & Preset Logic Control*

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE asynchronously loads signals into a register. Either LABCTRL1 or LABCTRL2 can control the asynchronous clear. Alternatively, the register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

During compilation, the Altera Compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six modes chosen during design entry:

- Asynchronous clear
- Asynchronous preset
- Asynchronous clear and preset
- Asynchronous load with clear
- Asynchronous load with preset
- Asynchronous load without clear or preset

When dedicated inputs drive non-inverted and inverted peripheral clears, clock enables, and output enables, two signals on the peripheral control bus will be used.

Tables 8 and 9 list the sources for each peripheral control signal, and show how the output enable, clock enable, clock, and clear signals share 12 peripheral control signals. The tables also show the rows that can drive global signals.

*Table 8. Peripheral Bus Sources for EPF10K30E, EPF10K50E & EPF10K50S Devices*

Peripheral Control Signal	EPF10K30E	EPF10K50E EPF10K50S
OE0	Row A	Row A
OE1	Row B	Row B
OE2	Row C	Row D
OE3	Row D	Row F
OE4	Row E	Row H
OE5	Row F	Row J
CLKENA0/CLK0/GLOBAL0	Row A	Row A
CLKENA1/OE6/GLOBAL1	Row B	Row C
CLKENA2/CLR0	Row C	Row E
CLKENA3/OE7/GLOBAL2	Row D	Row G
CLKENA4/CLR1	Row E	Row I
CLKENA5/CLK1/GLOBAL3	Row F	Row J

*Table 9. Peripheral Bus Sources for EPF10K100E, EPF10K130E, EPF10K200E & EPF10K200S Devices*

Peripheral Control Signal	EPF10K100E	EPF10K130E	EPF10K200E EPF10K200S
OE0	Row A	Row C	Row G
OE1	Row C	Row E	Row I
OE2	Row E	Row G	Row K
OE3	Row L	Row N	Row R
OE4	Row I	Row K	Row O
OE5	Row K	Row M	Row Q
CLKENA0/CLK0/GLOBAL0	Row F	Row H	Row L
CLKENA1/OE6/GLOBAL1	Row D	Row F	Row J
CLKENA2/CLR0	Row B	Row D	Row H
CLKENA3/OE7/GLOBAL2	Row H	Row J	Row N
CLKENA4/CLR1	Row J	Row L	Row P
CLKENA5/CLK1/GLOBAL3	Row G	Row I	Row M

Signals on the peripheral control bus can also drive the four global signals, referred to as GLOBAL0 through GLOBAL3 in [Tables 8 and 9](#). An internally generated signal can drive a global signal, providing the same low-skew, low-delay characteristics as a signal driven by an input pin. An LE drives the global signal by driving a row line that drives the peripheral bus, which then drives the global signal. This feature is ideal for internally generated clear or clock signals with high fan-out. However, internally driven global signals offer no advantage over the general-purpose interconnect for routing data signals. The dedicated input pin should be driven to a known logic state (such as ground) and not be allowed to float.

The chip-wide output enable pin is an active-high pin (DEV\_OE) that can be used to tri-state all pins on the device. This option can be set in the Altera software. On EPF10K50E and EPF10K200E devices, the built-in I/O pin pull-up resistors (which are active during configuration) are active when the chip-wide output enable pin is asserted. The registers in the IOE can also be reset by the chip-wide reset pin.

Table 13. ClockLock &amp; ClockBoost Parameters for -2 Speed-Grade Devices

Symbol	Parameter	Condition	Min	Typ	Max	Unit
$t_R$	Input rise time				5	ns
$t_F$	Input fall time				5	ns
$t_{INDUTY}$	Input duty cycle		40		60	%
$f_{CLK1}$	Input clock frequency (ClockBoost clock multiplication factor equals 1)		25		75	MHz
$f_{CLK2}$	Input clock frequency (ClockBoost clock multiplication factor equals 2)		16		37.5	MHz
$f_{CLKDEV}$	Input deviation from user specification in the MAX+PLUS II software (1)				25,000 (2)	PPM
$t_{INCLKSTB}$	Input clock stability (measured between adjacent clocks)				100	ps
$t_{LOCK}$	Time required for ClockLock or ClockBoost to acquire lock (3)				10	$\mu$ s
$t_{JITTER}$	Jitter on ClockLock or ClockBoost-generated clock (4)	$t_{INCLKSTB} < 100$			250	ps
		$t_{INCLKSTB} < 50$			200 (4)	ps
$t_{OUTDUTY}$	Duty cycle for ClockLock or ClockBoost-generated clock		40	50	60	%

**Notes to tables:**

- (1) To implement the ClockLock and ClockBoost circuitry with the MAX+PLUS II software, designers must specify the input frequency. The Altera software tunes the PLL in the ClockLock and ClockBoost circuitry to this frequency. The  $f_{CLKDEV}$  parameter specifies how much the incoming clock can differ from the specified frequency during device operation. Simulation does not reflect this parameter.
- (2) Twenty-five thousand parts per million (PPM) equates to 2.5% of input clock period.
- (3) During device configuration, the ClockLock and ClockBoost circuitry is configured before the rest of the device. If the incoming clock is supplied during configuration, the ClockLock and ClockBoost circuitry locks during configuration because the  $t_{LOCK}$  value is less than the time required for configuration.
- (4) The  $t_{JITTER}$  specification is measured under long-term observation. The maximum value for  $t_{JITTER}$  is 200 ps if  $t_{INCLKSTB}$  is lower than 50 ps.

## I/O Configuration

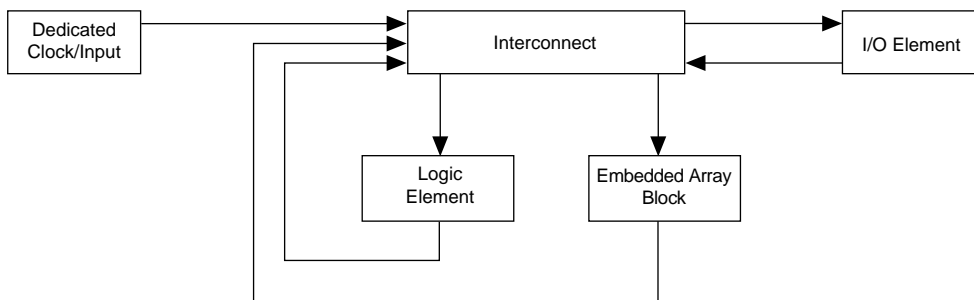
This section discusses the peripheral component interconnect (PCI) pull-up clamping diode option, slew-rate control, open-drain output option, and MultiVolt I/O interface for FLEX 10KE devices. The PCI pull-up clamping diode, slew-rate control, and open-drain output options are controlled pin-by-pin via Altera software logic options. The MultiVolt I/O interface is controlled by connecting  $V_{CCIO}$  to a different voltage than  $V_{CCINT}$ . Its effect can be simulated in the Altera software via the **Global Project Device Options** dialog box (Assign menu).



Timing simulation and delay prediction are available with the Altera Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time analysis, and device-wide performance analysis.

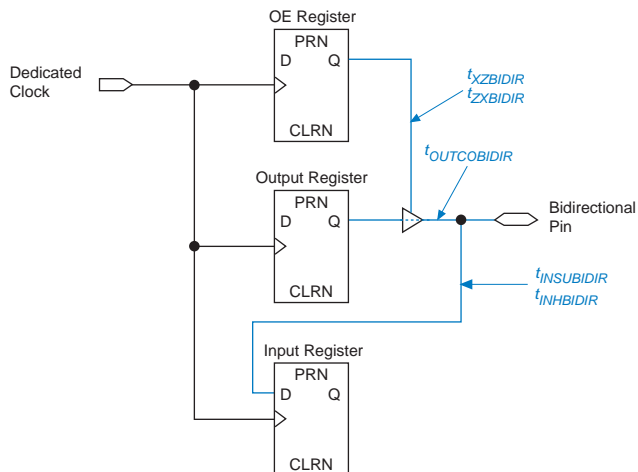
Figure 24 shows the overall timing model, which maps the possible paths to and from the various elements of the FLEX 10KE device.

Figure 24. FLEX 10KE Device Timing Model



Figures 25 through 28 show the delays that correspond to various paths and functions within the LE, IOE, EAB, and bidirectional timing models.

Figure 28. Synchronous Bidirectional Pin External Timing Model



Tables 24 through 28 describe the FLEX 10KE device internal timing parameters. Tables 29 through 30 describe the FLEX 10KE external timing parameters and their symbols.

Table 24. LE Timing Microparameters (Part 1 of 2) Note (1)

Symbol	Parameter	Condition
$t_{LUT}$	LUT delay for data-in	
$t_{CLUT}$	LUT delay for carry-in	
$t_{RLUT}$	LUT delay for LE register feedback	
$t_{PACKED}$	Data-in to packed register delay	
$t_{EN}$	LE register enable delay	
$t_{CICO}$	Carry-in to carry-out delay	
$t_{CGEN}$	Data-in to carry-out delay	
$t_{CGENR}$	LE register feedback to carry-out delay	
$t_{CASC}$	Cascade-in to cascade-out delay	
$t_C$	LE register control signal delay	
$t_{CO}$	LE register clock-to-output delay	
$t_{COMB}$	Combinatorial delay	
$t_{SU}$	LE register setup time for data and enable signals before clock; LE register recovery time after asynchronous clear, preset, or load	
$t_H$	LE register hold time for data and enable signals after clock	
$t_{PRE}$	LE register preset delay	

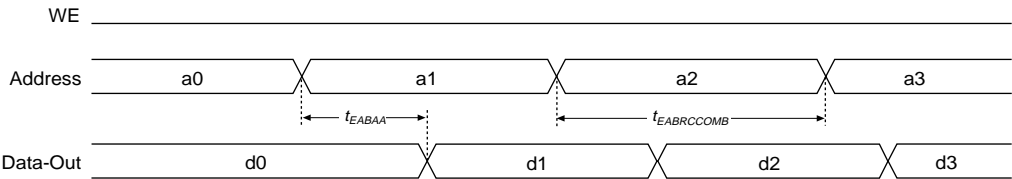
Table 26. EAB Timing Microparameters *Note (1)*

Symbol	Parameter	Conditions
$t_{EABDATA1}$	Data or address delay to EAB for combinatorial input	
$t_{EABDATA2}$	Data or address delay to EAB for registered input	
$t_{EABWE1}$	Write enable delay to EAB for combinatorial input	
$t_{EABWE2}$	Write enable delay to EAB for registered input	
$t_{EABRE1}$	Read enable delay to EAB for combinatorial input	
$t_{EABRE2}$	Read enable delay to EAB for registered input	
$t_{EABCLK}$	EAB register clock delay	
$t_{EABCO}$	EAB register clock-to-output delay	
$t_{EABYPASS}$	Bypass register delay	
$t_{EABSU}$	EAB register setup time before clock	
$t_{EABH}$	EAB register hold time after clock	
$t_{EABCLR}$	EAB register asynchronous clear time to output delay	
$t_{AA}$	Address access delay (including the read enable to output delay)	
$t_{WP}$	Write pulse width	
$t_{RP}$	Read pulse width	
$t_{WDSU}$	Data setup time before falling edge of write pulse	(5)
$t_{WDH}$	Data hold time after falling edge of write pulse	(5)
$t_{WASU}$	Address setup time before rising edge of write pulse	(5)
$t_{WAH}$	Address hold time after falling edge of write pulse	(5)
$t_{RASU}$	Address setup time with respect to the falling edge of the read enable	
$t_{RAH}$	Address hold time with respect to the falling edge of the read enable	
$t_{WO}$	Write enable to data output valid delay	
$t_{DD}$	Data-in to data-out valid delay	
$t_{EABOUT}$	Data-out delay	
$t_{EABCH}$	Clock high time	
$t_{EABCL}$	Clock low time	

Figures 29 and 30 show the asynchronous and synchronous timing waveforms, respectively, or the EAB macroparameters in Tables 26 and 27.

Figure 29. EAB Asynchronous Timing Waveforms

EAB Asynchronous Read



EAB Asynchronous Write

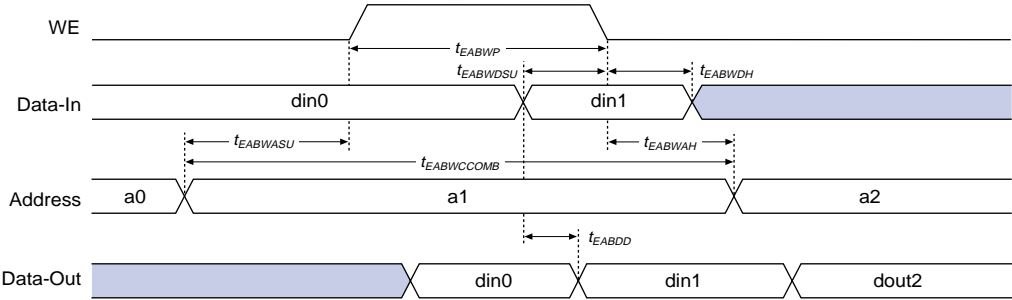


Table 33. EPF10K30E Device EAB Internal Microparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABDATA1}$		1.7		2.0		2.3	ns
$t_{EABDATA1}$		0.6		0.7		0.8	ns
$t_{EABWE1}$		1.1		1.3		1.4	ns
$t_{EABWE2}$		0.4		0.4		0.5	ns
$t_{EABRE1}$		0.8		0.9		1.0	ns
$t_{EABRE2}$		0.4		0.4		0.5	ns
$t_{EABCLK}$		0.0		0.0		0.0	ns
$t_{EABCO}$		0.3		0.3		0.4	ns
$t_{EABYPASS}$		0.5		0.6		0.7	ns
$t_{EABSU}$	0.9		1.0		1.2		ns
$t_{EABH}$	0.4		0.4		0.5		ns
$t_{EABCLR}$	0.3		0.3		0.3		ns
$t_{AA}$		3.2		3.8		4.4	ns
$t_{WP}$	2.5		2.9		3.3		ns
$t_{RP}$	0.9		1.1		1.2		ns
$t_{WDSU}$	0.9		1.0		1.1		ns
$t_{WDH}$	0.1		0.1		0.1		ns
$t_{WASU}$	1.7		2.0		2.3		ns
$t_{WAH}$	1.8		2.1		2.4		ns
$t_{RASU}$	3.1		3.7		4.2		ns
$t_{RAH}$	0.2		0.2		0.2		ns
$t_{WO}$		2.5		2.9		3.3	ns
$t_{DD}$		2.5		2.9		3.3	ns
$t_{EABOUT}$		0.5		0.6		0.7	ns
$t_{EABCH}$	1.5		2.0		2.3		ns
$t_{EABCL}$	2.5		2.9		3.3		ns

Table 47. EPF10K100E Device EAB Internal Microparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABDATA1}$		1.5		2.0		2.6	ns
$t_{EABDATA1}$		0.0		0.0		0.0	ns
$t_{EABWE1}$		1.5		2.0		2.6	ns
$t_{EABWE2}$		0.3		0.4		0.5	ns
$t_{EABRE1}$		0.3		0.4		0.5	ns
$t_{EABRE2}$		0.0		0.0		0.0	ns
$t_{EABCLK}$		0.0		0.0		0.0	ns
$t_{EABCO}$		0.3		0.4		0.5	ns
$t_{EABYPASS}$		0.1		0.1		0.2	ns
$t_{EABSU}$	0.8		1.0		1.4		ns
$t_{EABH}$	0.1		0.1		0.2		ns
$t_{EABCLR}$	0.3		0.4		0.5		ns
$t_{AA}$		4.0		5.1		6.6	ns
$t_{WP}$	2.7		3.5		4.7		ns
$t_{RP}$	1.0		1.3		1.7		ns
$t_{WDSU}$	1.0		1.3		1.7		ns
$t_{WDH}$	0.2		0.2		0.3		ns
$t_{WASU}$	1.6		2.1		2.8		ns
$t_{WAH}$	1.6		2.1		2.8		ns
$t_{RASU}$	3.0		3.9		5.2		ns
$t_{RAH}$	0.1		0.1		0.2		ns
$t_{WO}$		1.5		2.0		2.6	ns
$t_{DD}$		1.5		2.0		2.6	ns
$t_{EABOUT}$		0.2		0.3		0.3	ns
$t_{EABCH}$	1.5		2.0		2.5		ns
$t_{EABCL}$	2.7		3.5		4.7		ns

Table 48. EPF10K100E Device EAB Internal Timing Macroparameters (Part 1 of 2) *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABAA}$		5.9		7.6		9.9	ns
$t_{EABRCOMB}$	5.9		7.6		9.9		ns
$t_{EABRCREG}$	5.1		6.5		8.5		ns
$t_{EABWP}$	2.7		3.5		4.7		ns

Table 53. EPF10K130E Device IOE Timing Microparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{OD3}$		4.0		5.6		7.5	ns
$t_{XZ}$		2.8		4.1		5.5	ns
$t_{ZX1}$		2.8		4.1		5.5	ns
$t_{ZX2}$		2.8		4.1		5.5	ns
$t_{ZX3}$		4.0		5.6		7.5	ns
$t_{INREG}$		2.5		3.0		4.1	ns
$t_{IOFD}$		0.4		0.5		0.6	ns
$t_{INCOMB}$		0.4		0.5		0.6	ns

Table 54. EPF10K130E Device EAB Internal Microparameters (Part 1 of 2) *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABDATA1}$		1.5		2.0		2.6	ns
$t_{EABDATA2}$		0.0		0.0		0.0	ns
$t_{EABWE1}$		1.5		2.0		2.6	ns
$t_{EABWE2}$		0.3		0.4		0.5	ns
$t_{EABRE1}$		0.3		0.4		0.5	ns
$t_{EABRE2}$		0.0		0.0		0.0	ns
$t_{EABCLK}$		0.0		0.0		0.0	ns
$t_{EABCO}$		0.3		0.4		0.5	ns
$t_{EABYPASS}$		0.1		0.1		0.2	ns
$t_{EABSU}$	0.8		1.0		1.4		ns
$t_{EABH}$	0.1		0.2		0.2		ns
$t_{EABCLR}$	0.3		0.4		0.5		ns
$t_{AA}$		4.0		5.0		6.6	ns
$t_{WP}$	2.7		3.5		4.7		ns
$t_{RP}$	1.0		1.3		1.7		ns
$t_{WDSU}$	1.0		1.3		1.7		ns
$t_{WDH}$	0.2		0.2		0.3		ns
$t_{WASU}$	1.6		2.1		2.8		ns
$t_{WAH}$	1.6		2.1		2.8		ns
$t_{RASU}$	3.0		3.9		5.2		ns
$t_{RAH}$	0.1		0.1		0.2		ns
$t_{WO}$		1.5		2.0		2.6	ns

Table 59. EPF10K200E Device LE Timing Microparameters (Part 2 of 2) *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_H$	0.9		1.1		1.5		ns
$t_{PRE}$		0.5		0.6		0.8	ns
$t_{CLR}$		0.5		0.6		0.8	ns
$t_{CH}$	2.0		2.5		3.0		ns
$t_{CL}$	2.0		2.5		3.0		ns

Table 60. EPF10K200E Device IOE Timing Microparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{IOD}$		1.6		1.9		2.6	ns
$t_{IOC}$		0.3		0.3		0.5	ns
$t_{IOCO}$		1.6		1.9		2.6	ns
$t_{IOCOMB}$		0.5		0.6		0.8	ns
$t_{IOSU}$	0.8		0.9		1.2		ns
$t_{IOH}$	0.7		0.8		1.1		ns
$t_{IOCLR}$		0.2		0.2		0.3	ns
$t_{OD1}$		0.6		0.7		0.9	ns
$t_{OD2}$		0.1		0.2		0.7	ns
$t_{OD3}$		2.5		3.0		3.9	ns
$t_{XZ}$		4.4		5.3		7.1	ns
$t_{ZX1}$		4.4		5.3		7.1	ns
$t_{ZX2}$		3.9		4.8		6.9	ns
$t_{ZX3}$		6.3		7.6		10.1	ns
$t_{INREG}$		4.8		5.7		7.7	ns
$t_{IOFD}$		1.5		1.8		2.4	ns
$t_{INCOMB}$		1.5		1.8		2.4	ns



Table 61. EPF10K200E Device EAB Internal Microparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABDATA1}$		2.0		2.4		3.2	ns
$t_{EABDATA1}$		0.4		0.5		0.6	ns
$t_{EABWE1}$		1.4		1.7		2.3	ns
$t_{EABWE2}$		0.0		0.0		0.0	ns
$t_{EABRE1}$		0		0		0	ns
$t_{EABRE2}$		0.4		0.5		0.6	ns
$t_{EABCLK}$		0.0		0.0		0.0	ns
$t_{EABCO}$		0.8		0.9		1.2	ns
$t_{EABYPASS}$		0.0		0.1		0.1	ns
$t_{EABSU}$	0.9		1.1		1.5		ns
$t_{EABH}$	0.4		0.5		0.6		ns
$t_{EABCLR}$	0.8		0.9		1.2		ns
$t_{AA}$		3.1		3.7		4.9	ns
$t_{WP}$	3.3		4.0		5.3		ns
$t_{RP}$	0.9		1.1		1.5		ns
$t_{WDSU}$	0.9		1.1		1.5		ns
$t_{WDH}$	0.1		0.1		0.1		ns
$t_{WASU}$	1.3		1.6		2.1		ns
$t_{WAH}$	2.1		2.5		3.3		ns
$t_{RASU}$	2.2		2.6		3.5		ns
$t_{RAH}$	0.1		0.1		0.2		ns
$t_{WO}$		2.0		2.4		3.2	ns
$t_{DD}$		2.0		2.4		3.2	ns
$t_{EABOUT}$		0.0		0.1		0.1	ns
$t_{EABCH}$	1.5		2.0		2.5		ns
$t_{EABCL}$	3.3		4.0		5.3		ns

Table 62. EPF10K200E Device EAB Internal Timing Macroparameters (Part 1 of 2) *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABAA}$		5.1		6.4		8.4	ns
$t_{EABRCOMB}$	5.1		6.4		8.4		ns
$t_{EABRCREG}$	4.8		5.7		7.6		ns
$t_{EABWP}$	3.3		4.0		5.3		ns

Table 64. EPF10K200E External Timing Parameters Notes (1), (2)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{DRR}}$		10.0		12.0		16.0	ns
$t_{\text{INSU}}$	2.8		3.4		4.4		ns
$t_{\text{INH}}$	0.0		0.0		0.0		ns
$t_{\text{OUTCO}}$	2.0	4.5	2.0	5.3	2.0	7.8	ns
$t_{\text{PCISU}}$	3.0		6.2		-		ns
$t_{\text{PCIH}}$	0.0		0.0		-		ns
$t_{\text{PCICO}}$	2.0	6.0	2.0	8.9	-	-	ns

Table 65. EPF10K200E External Bidirectional Timing Parameters Notes (1), (2)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{INSUBIDIR}}$	3.0		4.0		5.5		ns
$t_{\text{INHBIDIR}}$	0.0		0.0		0.0		ns
$t_{\text{OUTCOBIDIR}}$	2.0	4.5	2.0	5.3	2.0	7.8	ns
$t_{\text{XZBIDIR}}$		8.1		9.5		13.0	ns
$t_{\text{ZXBIDIR}}$		8.1		9.5		13.0	ns

**Notes to tables:**

- (1) All timing parameters are described in Tables 24 through 30 in this data sheet.  
 (2) These parameters are specified by characterization.

Tables 66 through 79 show EPF10K50S and EPF10K200S device external timing parameters.

Table 66. EPF10K50S Device LE Timing Microparameters (Part 1 of 2) Note (1)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{\text{LUT}}$		0.6		0.8		1.1	ns
$t_{\text{CLUT}}$		0.5		0.6		0.8	ns
$t_{\text{RLUT}}$		0.6		0.7		0.9	ns
$t_{\text{PACKED}}$		0.2		0.3		0.4	ns
$t_{\text{EN}}$		0.6		0.7		0.9	ns
$t_{\text{CICO}}$		0.1		0.1		0.1	ns
$t_{\text{CGEN}}$		0.4		0.5		0.6	ns

Table 69. EPF10K50S Device EAB Internal Timing Macroparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{EABAA}$		3.7		5.2		7.0	ns
$t_{EABRCCOMB}$	3.7		5.2		7.0		ns
$t_{EABRCREG}$	3.5		4.9		6.6		ns
$t_{EABWP}$	2.0		2.8		3.8		ns
$t_{EABWCCOMB}$	4.5		6.3		8.6		ns
$t_{EABWCREG}$	5.6		7.8		10.6		ns
$t_{EABDD}$		3.8		5.3		7.2	ns
$t_{EABDATACO}$		0.8		1.1		1.5	ns
$t_{EABDATASU}$	1.1		1.6		2.1		ns
$t_{EABDATAH}$	0.0		0.0		0.0		ns
$t_{EABWESU}$	0.7		1.0		1.3		ns
$t_{EABWEH}$	0.4		0.6		0.8		ns
$t_{EABWDSU}$	1.2		1.7		2.2		ns
$t_{EABWDH}$	0.0		0.0		0.0		ns
$t_{EABWASU}$	1.6		2.3		3.0		ns
$t_{EABWAH}$	0.9		1.2		1.8		ns
$t_{EABWO}$		3.1		4.3		5.9	ns

Table 70. EPF10K50S Device Interconnect Timing Microparameters *Note (1)*

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{DIN2IOE}$		3.1		3.7		4.6	ns
$t_{DIN2LE}$		1.7		2.1		2.7	ns
$t_{DIN2DATA}$		2.7		3.1		5.1	ns
$t_{DCLK2IOE}$		1.6		1.9		2.6	ns
$t_{DCLK2LE}$		1.7		2.1		2.7	ns
$t_{SAMELAB}$		0.1		0.1		0.2	ns
$t_{SAMEROW}$		1.5		1.7		2.4	ns
$t_{SAMECOLUMN}$		1.0		1.3		2.1	ns
$t_{DIFFROW}$		2.5		3.0		4.5	ns
$t_{TWOROWS}$		4.0		4.7		6.9	ns
$t_{LEPERIPH}$		2.6		2.9		3.4	ns
$t_{LABCARRY}$		0.1		0.2		0.2	ns
$t_{LABCASC}$		0.8		1.0		1.3	ns

Table 73. EPF10K200S Device Internal &amp; External Timing Parameters

Note (1)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{LUT}$		0.7		0.8		1.2	ns
$t_{CLUT}$		0.4		0.5		0.6	ns
$t_{RLUT}$		0.5		0.7		0.9	ns
$t_{PACKED}$		0.4		0.5		0.7	ns
$t_{EN}$		0.6		0.5		0.6	ns
$t_{CICO}$		0.1		0.2		0.3	ns
$t_{CGEN}$		0.3		0.4		0.6	ns
$t_{CGENR}$		0.1		0.2		0.3	ns
$t_{CASC}$		0.7		0.8		1.2	ns
$t_C$		0.5		0.6		0.8	ns
$t_{CO}$		0.5		0.6		0.8	ns
$t_{COMB}$		0.3		0.6		0.8	ns
$t_{SU}$	0.4		0.6		0.7		ns
$t_H$	1.0		1.1		1.5		ns
$t_{PRE}$		0.4		0.6		0.8	ns
$t_{CLR}$		0.5		0.6		0.8	ns
$t_{CH}$	2.0		2.5		3.0		ns
$t_{CL}$	2.0		2.5		3.0		ns

Table 74. EPF10K200S Device IOE Timing Microparameters (Part 1 of 2)

Note (1)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
$t_{IOD}$		1.8		1.9		2.6	ns
$t_{IOC}$		0.3		0.3		0.5	ns
$t_{IOCO}$		1.7		1.9		2.6	ns
$t_{IOCOMB}$		0.5		0.6		0.8	ns
$t_{IOSU}$	0.8		0.9		1.2		ns
$t_{IOH}$	0.4		0.8		1.1		ns
$t_{IOCLR}$		0.2		0.2		0.3	ns
$t_{OD1}$		1.3		0.7		0.9	ns
$t_{OD2}$		0.8		0.2		0.4	ns
$t_{OD3}$		2.9		3.0		3.9	ns
$t_{XZ}$		5.0		5.3		7.1	ns
$t_{ZX1}$		5.0		5.3		7.1	ns

Additionally, the Altera software offers several features that help plan for future device migration by preventing the use of conflicting I/O pins.

*Table 81. I/O Counts for FLEX 10KA & FLEX 10KE Devices*

FLEX 10KA		FLEX 10KE	
Device	I/O Count	Device	I/O Count
EPF10K30AF256	191	EPF10K30EF256	176
EPF10K30AF484	246	EPF10K30EF484	220
EPF10K50VB356	274	EPF10K50SB356	220
EPF10K50VF484	291	EPF10K50EF484	254
EPF10K50VF484	291	EPF10K50SF484	254
EPF10K100AF484	369	EPF10K100EF484	338

## Configuration Schemes

The configuration data for a FLEX 10KE device can be loaded with one of five configuration schemes (see [Table 82](#)), chosen on the basis of the target application. An EPC1, EPC2, or EPC16 configuration device, intelligent controller, or the JTAG port can be used to control the configuration of a FLEX 10KE device, allowing automatic configuration on system power-up.

Multiple FLEX 10KE devices can be configured in any of the five configuration schemes by connecting the configuration enable ( $\overline{nCE}$ ) and configuration enable output ( $\overline{nCEO}$ ) pins on each device. Additional FLEX 10K, FLEX 10KA, FLEX 10KE, and FLEX 6000 devices can be configured in the same serial chain.

*Table 82. Data Sources for FLEX 10KE Configuration*

Configuration Scheme	Data Source
Configuration device	EPC1, EPC2, or EPC16 configuration device
Passive serial (PS)	BitBlaster, ByteBlasterMV, or MasterBlaster download cables, or serial data source
Passive parallel asynchronous (PPA)	Parallel data source
Passive parallel synchronous (PPS)	Parallel data source
JTAG	BitBlaster or ByteBlasterMV download cables, or microprocessor with a Jam STAPL file or JBC file